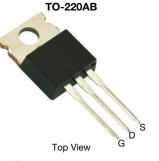
SUP90140E



Vishay Siliconix

N-Channel 200 V (D-S) 175 °C MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	R _{DS(on)} (Ω) MAX.	I _D (A)	Q _g (TYP.)		
200	0.017 at V _{GS} = 10 V	90	64 nC		
200	0.018 at V_{GS} = 7.5 V	88	04 HC		



Ordering Information:

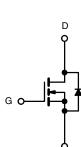
SUP90140E-GE3 (lead (Pb)-free and halogen-free)

FEATURES

- ThunderFET[®] power MOSFET
- Maximum 175 °C junction temperature
- 100 % R_g and UIS tested
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Power supplies:
 - Uninterruptible power supplies
 - AC/DC switch-mode power supplies
 - Lighting
- Synchronous rectification
- DC/DC converter
- Motor drive switch
- DC/AC inverter
- Solar micro inverter
- Class D audio amplifier



RoHS COMPLIANT

HALOGEN

FREE

ABSOLUTE MAXIMUM RATINGS (T	$C_{\rm C}$ = 25 °C, unless other	wise noted)			
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-Source Voltage		V _{DS}	200	V	
Gate-Source Voltage		V _{GS} ± 20		v	
Continuous Drain Current (T _{.1} = 150 °C)	T _C = 25 °C	1-	90	A	
Continuous Drain Current $(1) = 150^{\circ}$ C)	T _C = 70 °C	I _D	75		
Pulsed Drain Current (t = 100 µs)		I _{DM}	240	A	
Avalanche Current	L = 0.1 mH	I _{AS}	60		
Single Avalanche Energy ^a		E _{AS}	180	mJ	
Maximum Power Dissipation ^a	T _C = 25 °C	P	375 ^b	w	
Maximum Power Dissipation ~	T _C = 125 °C	— P _D	125 ^b		
Operating Junction and Storage Temperature Range		TJ, T _{stg}	-55 to +175	°C	

THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	LIMIT	UNIT	
Junction-to-Ambient (PCB Mount) ^c	R _{thJA}	40	°C/W	
Junction-to-Case (Drain)	R _{thJC}	0.4	0/10	

Notes

- a. Duty cycle ≤ 1 %.
- b. See SOA curve for voltage derating.
- c. When mounted on 1" square PCB (FR4 material).

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SPECIFICATIONS (T _J = 25 °C, unless otherwise noted)							
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static				-			
Drain-Source Breakdown Voltage	V _{DS}	V_{GS} = 0 V, I_D = 250 μ A	200	-	-	V	
Gate Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS},\ I_D=250\ \mu A$	2	-	4	v	
Gate-Body Leakage	I _{GSS}	V_{DS} = 0 V, V_{GS} = ± 20 V	-	-	± 250	nA	
		$V_{DS} = 200 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	-	1	μA	
Zero Gate Voltage Drain Current	I _{DSS}	V_{DS} = 200 V, V_{GS} = 0 V, T_J = 125 $^\circ C$	-	-	150		
		V_{DS} = 200 V, V_{GS} = 0 V, T_J = 175 $^\circ C$	-	-	5	mA	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \geq 10 \ V, \ V_{GS} = 10 \ V$	90	-	-	А	
Drain Source On State Desistance 3	Б	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 30 \text{ A}$	-	0.0138	0.0170	0	
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = 7.5 \text{ V}, \text{ I}_{D} = 30 \text{ A}$	-	0.0141	0.0180	Ω	
Forward Transconductance ^a	9 _{fs}	$V_{DS} = 15 \text{ V}, I_D = 30 \text{ A}$	-	75	-	S	
Dynamic ^b							
Input Capacitance	C _{iss}		-	4132	-	pF	
Output Capacitance	C _{oss}	V _{GS} = 0 V, V _{DS} = 100 V, f = 1 MHz	-	246	-		
Reverse Transfer Capacitance	C _{rss}		-	21	-		
Total Gate Charge ^c	Qg		-	64	96	nC	
Gate-Source Charge ^c	Q _{gs}	$V_{DS} = 100 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 60 \text{ A}$	-	16.7	-		
Gate-Drain Charge ^c	Q _{gd}		-	16.9	-		
Gate Resistance	Rg	f = 1 MHz	1.5	3	5	Ω	
Turn-On Delay Time ^c	t _{d(on)}		-	13	26		
Rise Time ^c	t _r	$V_{DD} = 100 \text{ V}, \text{ R}_{L} = 1.66 \Omega$	-	112	200	ns	
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong 60 \text{ A}, V_{GEN} = 10 \text{ V}, \text{ R}_g = 1 \Omega$	-	35	70		
Fall Time ^c	t _f		-	80	150		
Drain-Source Body Diode Ratings a	nd Characteri	stics ^b (T _C = 25 °C)					
Pulsed Current (t = 100 µs)	I _{SM}		-	-	240	А	
Forward Voltage ^a	V _{SD}	$I_F = 10 \text{ A}, V_{GS} = 0 \text{ V}$	-	0.8	1.2	V	
Reverse Recovery Time	t _{rr}		-	160	320	ns	
Peak Reverse Recovery Charge	I _{RM(REC)}	 I _F = 30 A, di/dt = 100 A/μs	-	11	20	А	
Reverse Recovery Charge	Q _{rr}		-	0.9	1.8	μC	

Notes

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

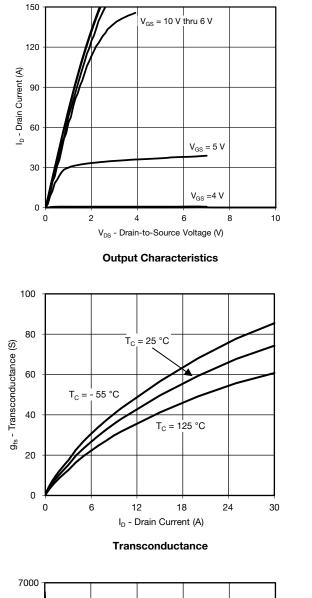
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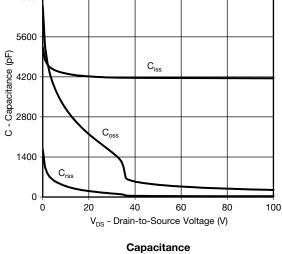


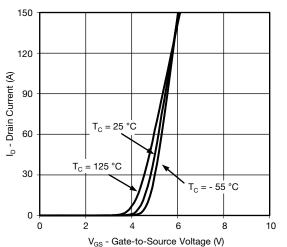
SUP90140E

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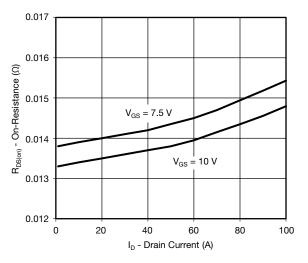
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)

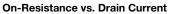


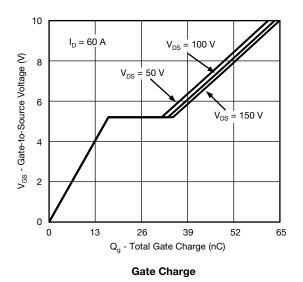




Transfer Characteristics







S15-2641-Rev. A, 16-Nov-15

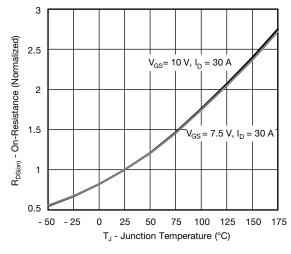
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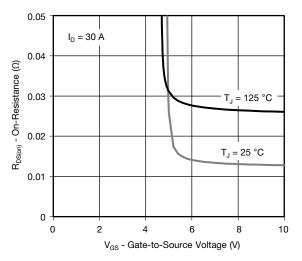




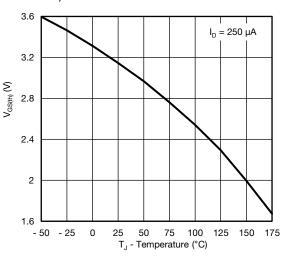
TYPICAL CHARACTERISTICS ($T_A = 25 \text{ °C}$, unless otherwise noted)



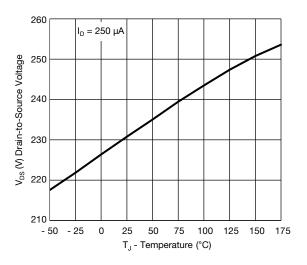
On-Resistance vs. Junction Temperature



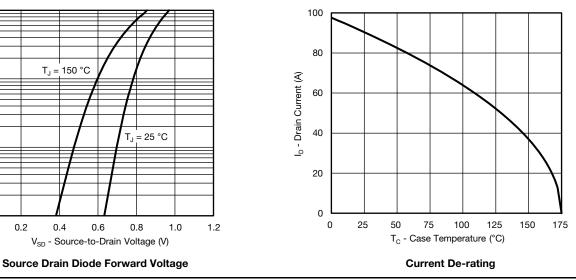
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage



Drain Source Breakdown vs. Junction Temperature



S15-2641-Rev. A, 16-Nov-15

100

10

1

0.1

0.0

I_s - Source Current (A)

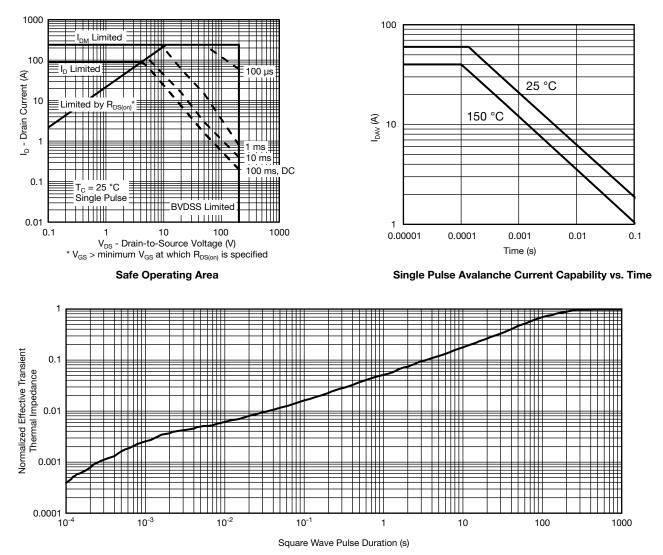
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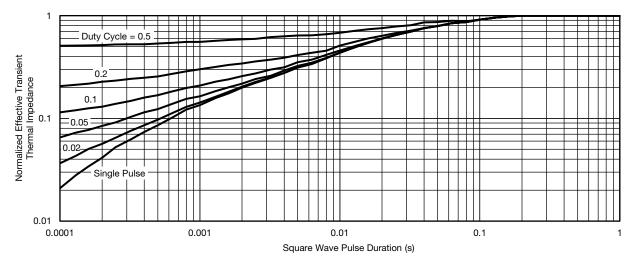
THERMAL RATINGS (T_A = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



THERMAL RATINGS (T_A = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Case

Note

• The characteristics shown in the two graphs

- Normalized Transient Thermal Impedance Junction to Ambient (25 °C)

- Normalized Transient Thermal Impedance Junction to Case (25 °C)

are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions.

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TO-220AB



	MILLIMETERS		INCHES		
DIM.	MIN.	MAX.	MIN.	MAX.	
А	4.25	4.65	0.167	0.183	
b	0.69	1.01	0.027	0.040	
b(1)	1.20	1.73	0.047	0.068	
С	0.36	0.61	0.014	0.024	
D	14.85	15.49	0.585	0.610	
D2	12.19	12.70	0.480	0.500	
E	10.04	10.51	0.395	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.09	6.48	0.240	0.255	
J(1)	2.41	2.92	0.095	0.115	
L	13.35	14.02	0.526	0.552	
L(1)	3.32	3.82	0.131	0.150	
ØР	3.54	3.94	0.139	0.155	
Q	2.60	3.00	0.102	0.118	
	0413-Rev. P,		0.102	0.118	

Note

 * M = 1.32 mm to 1.62 mm (dimension including protrusion) Heatsink hole for HVM



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